

## TURBO 2 ULTRAFAST HIGH VOLTAGE RECTIFIER

### MAIN PRODUCT CHARACTERISTICS

$I_{F(AV)}$	5 A
$V_{RRM}$	600 V
$I_R$ (max)	125 $\mu$ A
$T_j$ (max)	175 °C
$V_F$ (max)	1.05 V
$t_{rr}$ (max)	95 ns

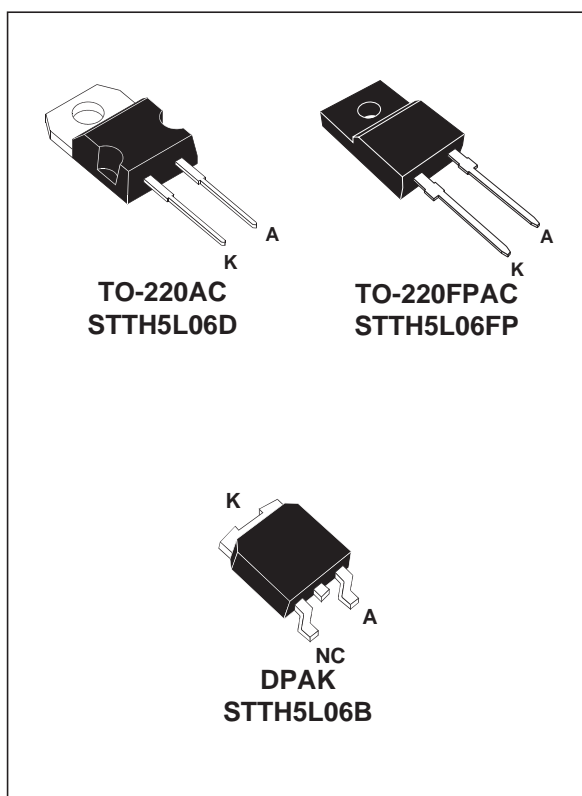
### FEATURES AND BENEFITS

- Ultrafast switching
- Low reverse recovery current
- Reduces switching & conduction losses
- Low thermal resistance

### DESCRIPTION

The STTH5L06D/B/FP, which is using ST Turbo 2 600V technology, is specially suited as boost diode in discontinuous or critical mode power factor corrections.

The device, available in TO-220AC, TO-220FPAC and DPAK, is also intended for use as a free wheeling diode in power supplies and other power switching applications.



### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit	
$V_{RRM}$	Repetitive peak reverse voltage		600	V	
$I_{F(RMS)}$	RMS forward current		TO-220AC/TO-220FPAC DPAK	20 10 A	
$I_{F(AV)}$	Average forward current	TO-220AC / DPAK	$T_c = 150^\circ\text{C}$ $\delta = 0.5$	5	A
		TO-220FPAC	$T_c = 135^\circ\text{C}$ $\delta = 0.5$		
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10$ ms Sinusoidal	TO-220AC/TO-220FPAC DPAK	90	A
		$t_p = 10$ ms Sinusoidal		60	
$T_{stg}$	Storage temperature range		- 65 + 175	°C	
$T_j$	Maximum operating junction temperature		+ 175	°C	

# STTH5L06D/B/FP

## THERMAL PARAMETERS

Symbol	Parameter		Maximum	Unit
R <sub>th(j-c)</sub>	Junction to case	TO-220AC / DPAK	3.5	°C/W
		TO-220FPAC	6.0	

## STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I <sub>R</sub>	Reverse leakage current	V <sub>R</sub> = 600V	T <sub>j</sub> = 25°C			5	μA
			T <sub>j</sub> = 150°C		10	125	
V <sub>F</sub>	Forward voltage drop	I <sub>F</sub> = 5 A	T <sub>j</sub> = 25°C			1.3	V
			T <sub>j</sub> = 150°C		0.85	1.05	

To evaluate the maximum conduction losses use the following equation :  
 $P = 0.89 \times I_{F(AV)} + 0.033 I_{F(RMS)}^2$

## DYNAMIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	I <sub>F</sub> = 1 A dI <sub>F</sub> /dt = - 50 A/μs V <sub>R</sub> = 30V	T <sub>j</sub> = 25°C		65	95	ns
t <sub>fr</sub>	Forward recovery time	I <sub>F</sub> = 5 A dI <sub>F</sub> /dt = 100 A/μs V <sub>FR</sub> = 1.1 x V <sub>Fmax</sub>	T <sub>j</sub> = 25°C			150	ns
V <sub>FP</sub>	Forward recovery time	I <sub>F</sub> = 5 A dI <sub>F</sub> /dt = 100 A/μs	T <sub>j</sub> = 25°C			7	V

Fig. 1: Conduction losses versus average current.

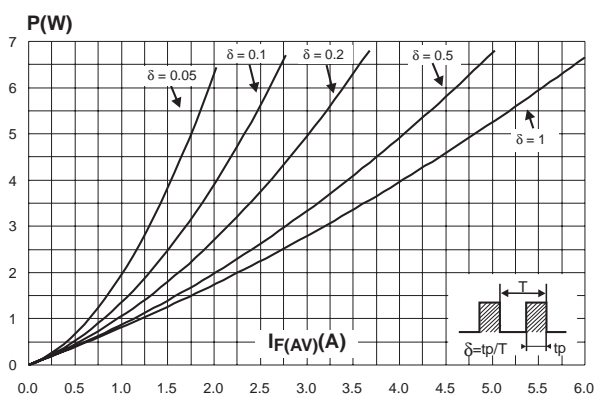
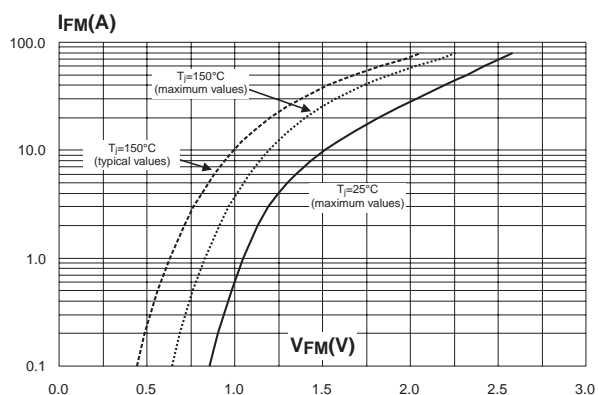
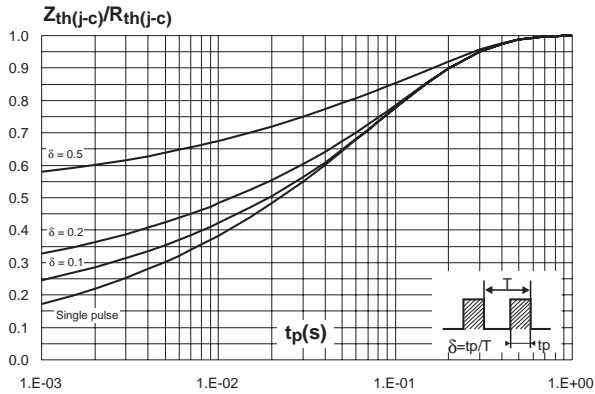


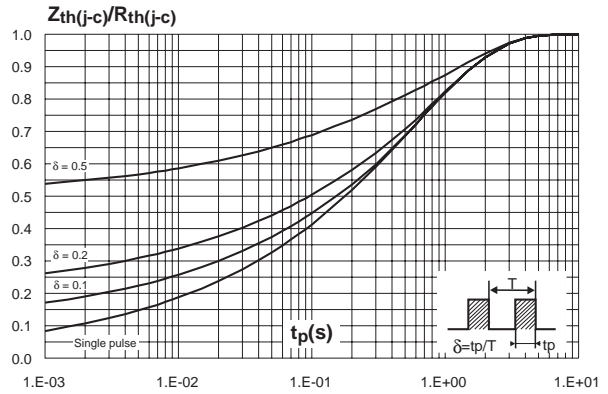
Fig. 2: Forward voltage drop versus forward current.



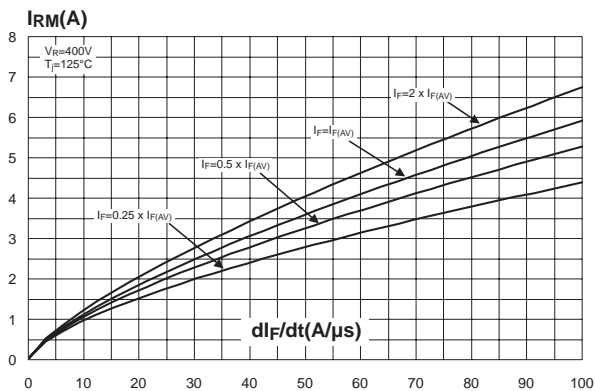
**Fig. 3-1:** Relative variation of thermal impedance junction to case versus pulse duration (TO-220AC, DPAK).



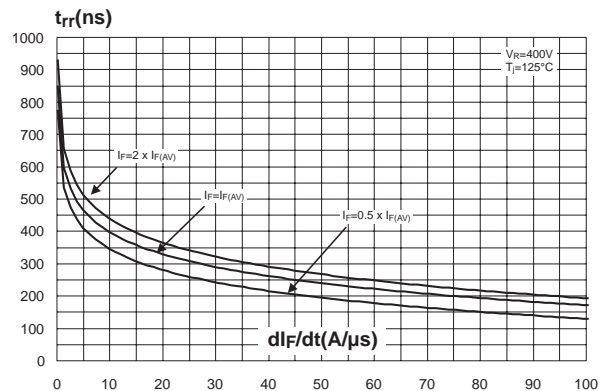
**Fig. 3-2:** Relative variation of thermal impedance junction to case versus pulse duration (TO-220FPAC).



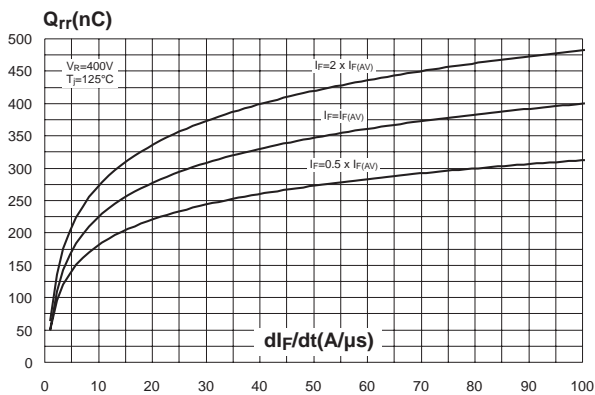
**Fig. 4:** Peak reverse recovery current versus  $di_F/dt$  (90% confidence).



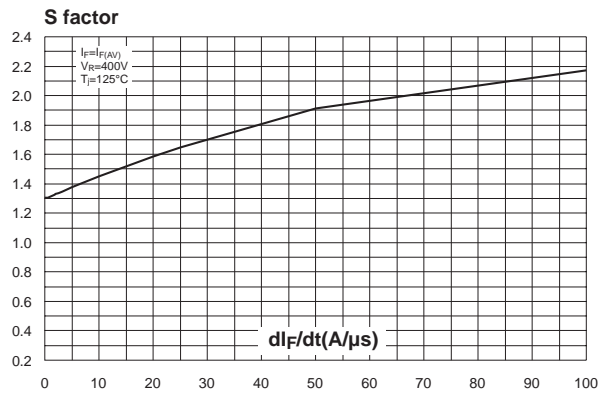
**Fig. 5:** Reverse recovery time versus  $di_F/dt$  (90% confidence).



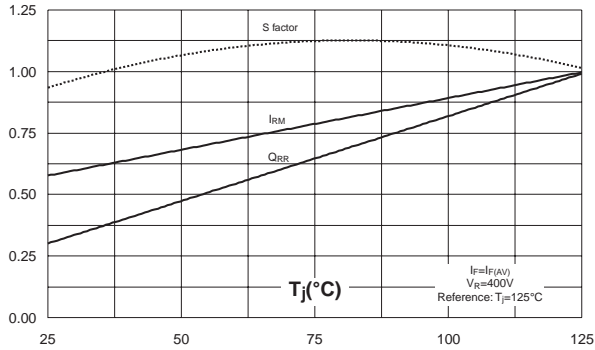
**Fig. 6:** Reverse recovery charges versus  $di_F/dt$  (90% confidence).



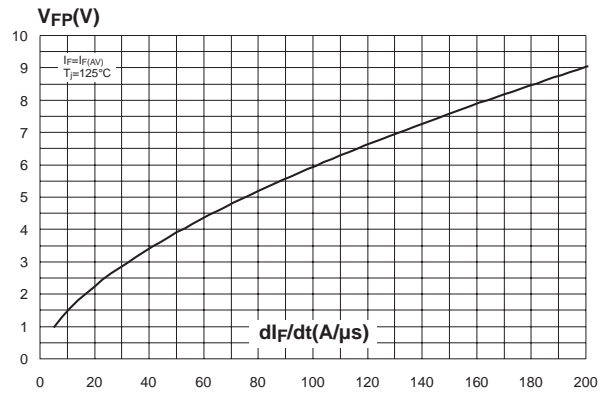
**Fig. 7:** Softness factor versus  $di_F/dt$  (typical values).



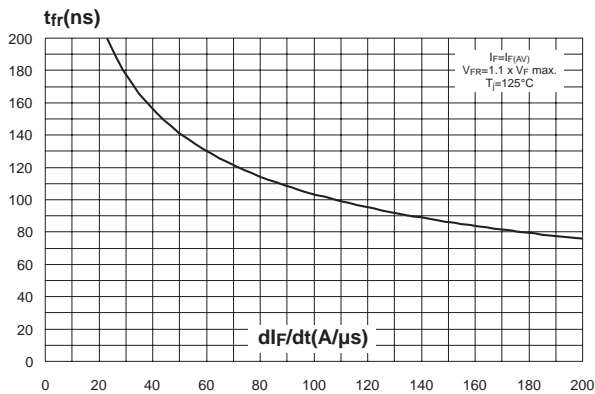
**Fig. 8:** Relative variations of dynamic parameters versus junction temperature.



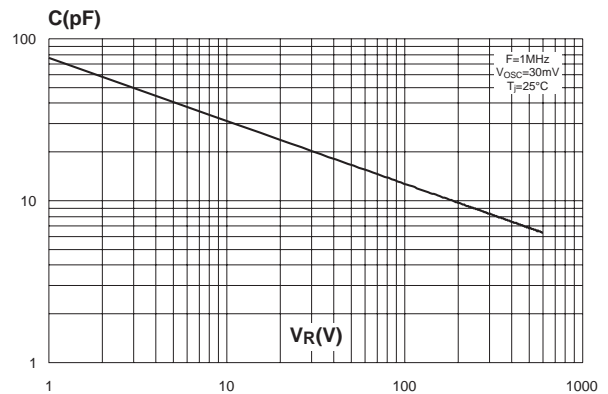
**Fig. 9:** Transient peak forward voltage versus  $di_F/dt$  (90% confidence).



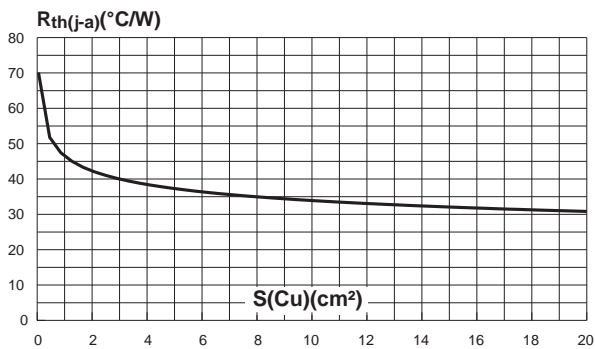
**Fig. 10:** Forward recovery time versus  $di_F/dt$  (90% confidence).



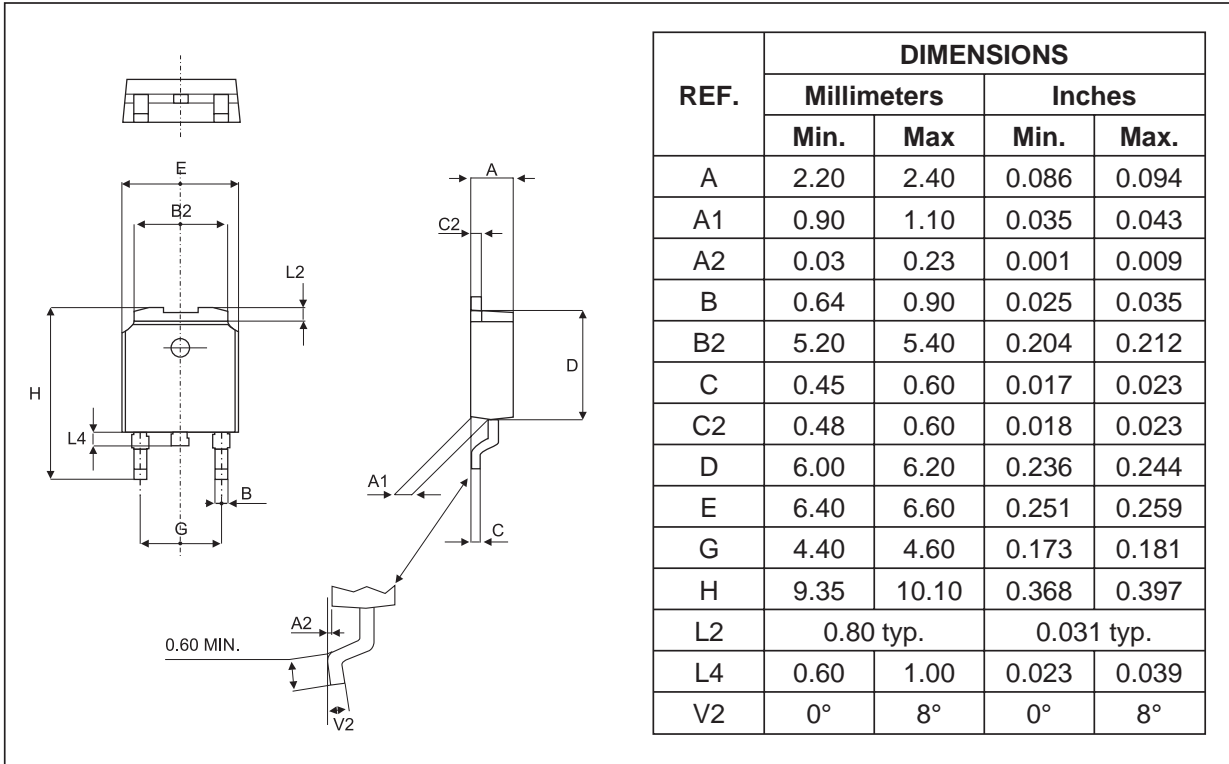
**Fig. 11:** Junction capacitance versus reverse voltage applied (typical values).



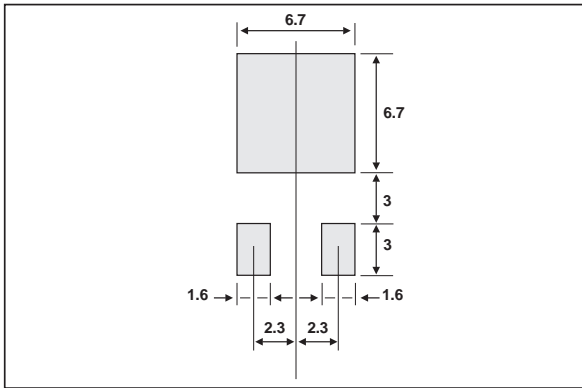
**Fig. 12:** Thermal resistance junction to ambient versus copper surface under tab (epoxy printed circuit board FR4, copper thickness: 35 $\mu m$ ) (DPAK).



**PACKAGE MECHANICAL DATA**  
DPAK

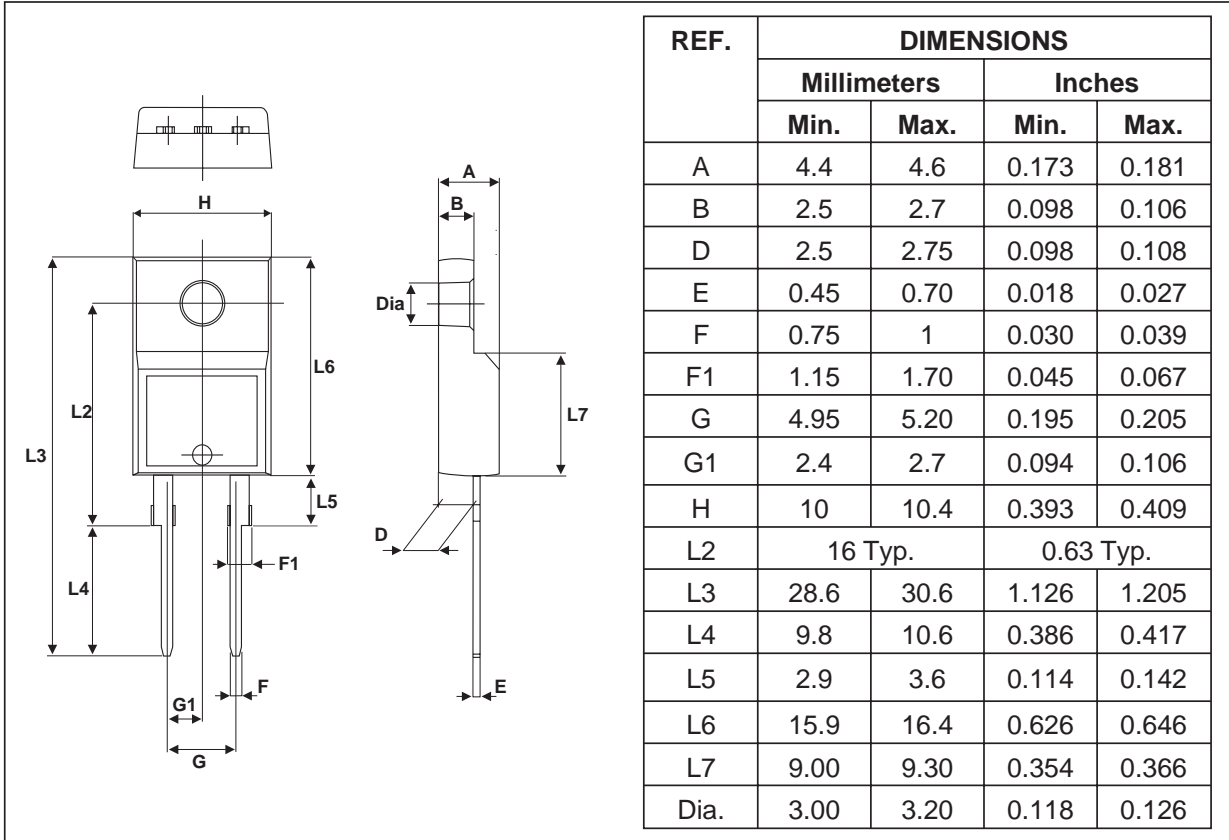


**FOOTPRINT**



**STTH5L06D/B/FP**

**PACKAGE MECHANICAL DATA**  
TO-220FPAC



**PACKAGE MECHANICAL DATA**  
 TO-220AC

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
C	1.23	1.32	0.048	0.051
D	2.40	2.72	0.094	0.107
E	0.49	0.70	0.019	0.027
F	0.61	0.88	0.024	0.034
F1	1.14	1.70	0.044	0.066
G	4.95	5.15	0.194	0.202
H2	10.00	10.40	0.393	0.409
L2	16.40 typ.		0.645 typ.	
L4	13.00	14.00	0.511	0.551
L5	2.65	2.95	0.104	0.116
L6	15.25	15.75	0.600	0.620
L7	6.20	6.60	0.244	0.259
L9	3.50	3.93	0.137	0.154
M	2.6 typ.		0.102 typ.	
Diam. I	3.75	3.85	0.147	0.151

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
STTH5L06D	STTH5L06D	TO-220AC	1.9 g	50	Tube
STTH5L06B	STTH5L06B	DPAK	0.3 g	75	Tube
STTH5L06B-TR	STTH5L06B	DPAK	0.3 g	2500	Tape & reel
STTH5L06FP	STTH5L06FP	TO-220PFAC	1.7 g	50	Tube

- Epoxy meets UL 94, V0
- Recommended torque value (TO-220AC): 0.55 Nm
- Maximum torque value (TO-220AC / TO-220FPAC): 0.7 Nm

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